EPO-TEK® H31

Epoxy; Epoxide

Epoxy Technology Inc.

Message:

EPO-TEK® H31 is a single component, silver-filled, electrically conductive epoxy designed for semiconductor die attach applications found in hybrids, JEDEC, and opto-electronic packaging.

| General Information | | | | | |
|-----------------------------------|------------------------------------|------|-----|--|--|
| Filler / Reinforcement | Silver | | | | |
| Features | Electrically Conductive | | | | |
| | Electromagnetic Shielding (EMI) | | | | |
| | Low to No Outgassing | | | | |
| | Radio Frequency Shielding (RFI) | | | | |
| | Thixotropic | | | | |
| Uses | Adhesives | | | | |
| | Electrical/Electronic Applications | | | | |
| | LCD Applications | | | | |
| | LEDs | | | | |
| | Printed Circuit Boards | | | | |
| Agency Ratings | ASTM E 595 | | | | |
| | EC 1907/2006 (REACH) | | | | |
| | EU 2003/11/EC | | | | |
| | EU 2006/122/EC | | | | |
| RoHS Compliance | RoHS Compliant | | | | |
| Forms | Paste | | | | |
| Physical | Nominal Value | Unit | | | |
| Ion Type | | | | | |
| CI- | 7 | ppm | | | |
| K+ | 41 | ppm | | | |
| Na+ | 143 | ppm | | | |
| NH4+ | 8 | ppm | | | |
| Particle Size | < 45.0 | μm | | | |
| Degradation Temperature | 370 | °C | TGA | | |
| Die Shear Strength - >5 kg (23°C) | 11.7 | MPa | | | |
| Operating Temperature | | | | | |
| Continuous | -55 to 200 | °C | | | |
| Intermittent | -55 to 300 | °C | | | |

| Storage Modulus (23°C) | 5.69 | GPa | |
|---|--|----------|-------------|
| Thixotropic Index | 3.00 | | |
| Weight Loss on Heating (250°C) | 0.060 | % | |
| Thermal | Nominal Value | Unit | |
| Glass Transition Temperature ¹ | > 110 | °C | |
| CLTE - Flow | | | |
| 2 | 4.8E-5 | cm/cm/°C | |
| 3 | 2.0E-4 | cm/cm/°C | |
| Thermal Conductivity | 1.1 | W/m/K | |
| Thermoset | Nominal Value | Unit | Test Method |
| Shelf Life (23°C) | 13 | wk | |
| Uncured Properties | Nominal Value | Unit | Test Method |
| Color | Silver | | |
| Density | 2.19 | g/cm³ | |
| Viscosity ⁴ (23°C) | 15 to 25 | Pa∙s | |
| Curing Time (150°C) | 1.0 | hr | |
| Pot Life | 40000 | min | |
| Cured Properties | Nominal Value | Unit | Test Method |
| Shore Hardness (Shore D) | 84 | | |
| Lap Shear Strength (23°C) | 9.10 | MPa | |
| Volume Resistivity (23°C) | < 5.0E-4 | ohms·cm | |
| NOTE | | | |
| 1. | Dynamic Cure 20-200°C/ISO 25 Min; Ramp -10-250°C @ 20°C/Min | | |
| 2. | Below Tg | | |
| 3. | Above Tg | | |
| 4. | 5 rpm | | |

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